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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Application Number		10585275
	Filing Date		2006-07-05
	First Named Inventor	Nancy Dean	
	Art Unit	2835	
	Examiner Name	Unknown	
	Attorney Docket Number	H0005430.75230 USA -4018	

U.S.PATENTS						
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